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## Delayed avalanche breakdown of high-voltage Si diodes: scenarios and mechanisms of picosecond-range switching

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Delayed avalanche breakdown of reversely biased high voltage Si diodes, known as Silicon Avalanche Shapers (SAS), leads to ~100 ps switching and has found important pulse power applications. The widely accepted model of delaye d breakdown is a TRAPATT-like ionizing wave that propagates faster than the saturated drift velocity vs. and leaves dense electron-hole plasma behind (see Ref. 1 and references therein). However, both analytical theory and numerical simulations show that TRAPATT-like wave in Si at typical electric field of ~300 kV/cm is roughly 3 times slower than it is needed to explain 100 ps switching [1].

In this presentation we point out flaws of the TRAPATT-like wave concept in application to SAS diodes and discuss alternative mechanisms of ultrafast avalanche switching. These are scenarios of filamentary backstroke ionization [2], the concept of non-TRAPATT-like ionizing wave in low-doped structures [3] and, finally, straighforward but efficient mechanism of quasi-uniform avalanche breakdown. First, we argue that experimentally observed switching time of ~100 ps can be explained assuming that only part of the device cross-section is modulated. We show that such current localization results in qualitative difference in switching dynamics. Second, we describe ionizing waves that differ from TRAPATT-like waves in propagation mechanism and formulate physical conditions for their excitation in SAS diodes [3]. Finally, we demonstrate that avalanche switching with rise-time below ~100 ps may occur in spatially uniform manner even in pindiodes where front propagation is impossible. These results are also applicable to optically activated switches. The critical parameters for successfull ps-range switching are the ratio of the maximum electric field to the ionization threshold and the ratio of the RC-time (determined by the intrinsic device capacitance and the external load) to the inverse impact ionization rate.

[1] P. Rodin, U. Ebert, A. Minarsky, I. Grekhov, J. Appl. Phys. 102(3), 034508, 2007.

[2] P. Rodin, A. Minarsky, I. Grekhov, J. Appl. Phys. 108(3), 034501, 2010

[3] P. Rodin, A. Minarsky, I. Grekhov, Technical Physics Letters, 38(6), 535, 2012.

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